For use with IDT's VCXO-based Synchronization PLLs

Specifications

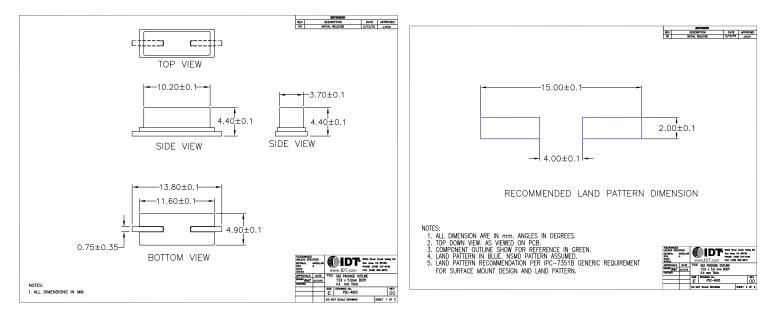
Parameters

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Frequency	25.78125 MHz	
Resonance Mode	Fundamental	
Frequency Tolerance @ 25°C	±20 PPM	
Frequency Stability, ref @ 25°C Over Operating Temperature Range	±20 PPM	
Temperature Range Operating (TOPR)	-40°C ~ +85°C	
Temperature Range, Storage (Tstg)	-40°C ~ +85°C	
Equivalent Series Resistance (ESR)	20 Ohms	
Shunt Capacitance (Co)	7 pF	
Load Capacitance (CL)	10 pF	
Drive Level	0.5 mW	
Aging per year	±5 PPM	
Maximum Soldering Temp / Time	260°C / 10 Seconds	
Moisture Sensitivity Level (MSL)	1	
Termination Finish (96.5% - 3% - 0.5%)	Sn - Ag - Cu	
Weight (TYP)	649.385 mg	

Note: Dimensional drawing is for reference to critical specifications defined by size measurements. Certain non-critical visual attributes, such as side castellations, etc. may vary. The above specifications, having been carefully prepared and checked, is believed to be accurate at the time of publication; however, no responsibility is assumed by IDT for inaccuracies. All specifications subject to change without notice.

Ratings/Units

Package Outline and Dimensions (SA2)



Ordering Information

Part / Order Number	Shipping Packaging	Package	Temperature
278-25.78125-1SA2I	Cut-Tape	13.9 x 5.0 x 4.4 mm SA2	-40° to +85°
278-2578125-1SA2I8	Tape and Reel	13.9 x 5.0 x 4.4 mm SA2	-40° to +85°

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